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MD240128A6W-FPTLW 240 x 128		LCD Modu l e			
		Specification			
Version: 1		Date: 30/07/2020			
	Revision				
1	29/07/2020	First Issue			

Disp l ay F					
Resolution	240 x 128				
Appearance	Black on White				
Logic Voltage	3.3V				
Interface	Para l lel/SPI	ROHS			
Font Set	N/A	RoHS			
Display Mode	Transflectiv <mark>e</mark>	Compilant			
LC Type	FSTN				
Module Size	140.00 x 84.00 x 9.70 mm				
Operating Temperature	-20°C ~ +70°C				
Construction	СОВ	Box Quantity Weight / Display			
LED Backlight	White	re . Suppty			

* - For full design functionality, please use this specification in conjunction with the ST7586S specification.(Provided Separately)

Display Accessories					
Part Number	Description				

Optional Variants				
Appearances	Voltage			

General Specification

The Features is described as follow:

■ Module dimension: 140.0 x 84.0 x 9.7 mm

■ View area: 114.0 x 64.0 mm

■ Active area: 107.98 x 57.58 mm

■ Number of dots: 240 x 128

■ Dot size: 0.43 x 0.43 mm

■ Dot pitch: 0.45 x 0.45 mm

■ LCD type: FSTN Positive Transflective

■ Duty: 1/128Duty , 1/12Bias

■ View direction: 6 o'clock

■ Backlight Type: LED White

■ IC: ST7586S

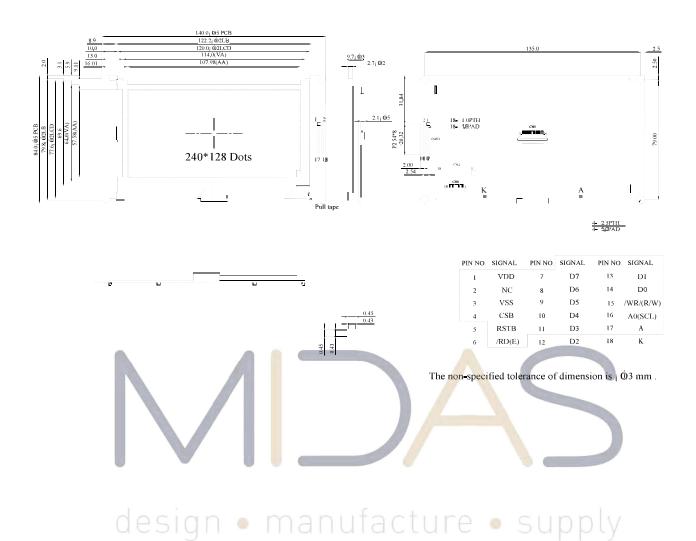
Interface Pin Function

Pin No.	Symbol	Description						
1	VDD	Power supp l y						
2	NC	No connection						
3	VSS	Ground						
4	CSB	Chip select input pin CSB="L": This chip is selected and the MPU interface is active CSB="H": This chip is not selected and the MPU interface is disabled (D[7:0] are high impedance)						
5	RSTB	Reset input pin. When RSTB is "L", internal initialization procedure is						
6	/RD(E)	Read / Write execution control pin. (This pin is only used in parallelinterface) MPU Type						
7~14	D7~D0	The bi-directional data bus of the MPU interface. When CSB is "H", they are high impedance If using serial interface: D0 is the SDA signal in 4-Line & 3-Line interface D1 is the A0 signal in 4-Line interface						
		Read / Write execution control pin. (This pin is only used in parallel interface)						
		MPU Type RWR Description						
15	/WR/(R/W)	Read / Write control input pin 6800-series R/W R/W = "H" : read R/W = "L" : write						
		8080-series /WR Write enable clock input pin. The data are latched at the rising edge of the /WR signal.						
		This pin is not used in serial interfaces and should be connected to VDD1						

16	A0(SCL)	The function of this pin is different in parallel and serial interface In parallel interface: A0 is register selection input A0 = "H": inputs on data bus are display data A0 = "L": inputs on data bus are command In serial interface: this pad will be used as SCL (serial-clock) input
17	Α	LED+
18	K	LED-



Contour Drawing

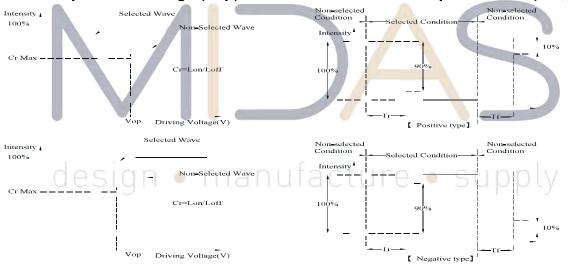


Optical Characteristics

Item	Item Symbol		Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	ψ= 180°
View Angle	θ	CR≧2	0	_	60	ψ= 0°
View Angle	θ	CR≧2	0	_	45	ψ= 90°
	θ	CR≧2	0	_	45	ψ= 270°
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fa ll	_	_	250	350	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)

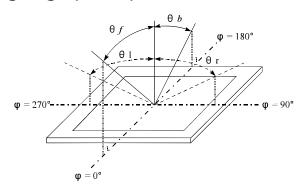


Conditions:

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle(CR≥2)



Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Top	- 20	_	+70	°C
Storage Temperature	T _{ST}	-30	_	+80	°C
Digital Power Supply Voltage	VDDI	-0.3	_	3.6	V
Analog Power supply voltage	VDDA	-0.3	_	3.6	V
LCD Power supply voltage	V0-XV0	-0.3	_	19	V
LCD Power supply voltage	VG	-0.3	_	5.5	V

Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V _{DD} -V _S		3.0	3.3	3.6	V
Supply Voltage For LCM	VOP	Ta=-20℃ Ta=25℃	_ 14.8	_ 15.0	_ 15.2	v V
		Ta=+70℃	_	-	_	V
Input High Volt.	VIH		0.7V _{DD}	ı	V _{DD}	٧
Input Low Volt.	VIL	ı	Vss	l	0.3 V _{DD}	٧
Output High Vo l t.	Vон	ı	0.8 V _{DD}	l	V _{DD}	V
Output Low Vo l t.	V _{OL}	ı	Vss	l	0.2V _{DD}	V
Supp l y Current	I DD	V _{DD} =3.3V	_	2.0	4.0	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

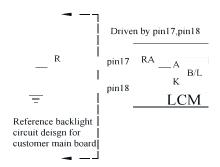
Backlight Information

Specification

poomoution						
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED		144	180	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	٧	_
Reverse Voltage	VR		_	5	٧	_
Color	Х	0.244	0.264	0.284		U FD=4.44 A
coordinate	Y	0.264	0.284	0.304	<u> </u>	ILED=144mA
Luminance	IV	750	940		ad/m²	ILED=144mA
(Without LCD)	IV	750	540		Cu/m-	ILED-144MA
LED Life Time		1				ILED=144mA
(For Reference	-/		50K	-)	Hr.	<mark>25℃,50-60%RH,</mark>
only)						(Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

Environmental Test							
Test Item	Content of Test	Test Condition	Note				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	96hrs	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 96hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 96hrs					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 96hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles					
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times					

Note1: No dew condensation to be observed.

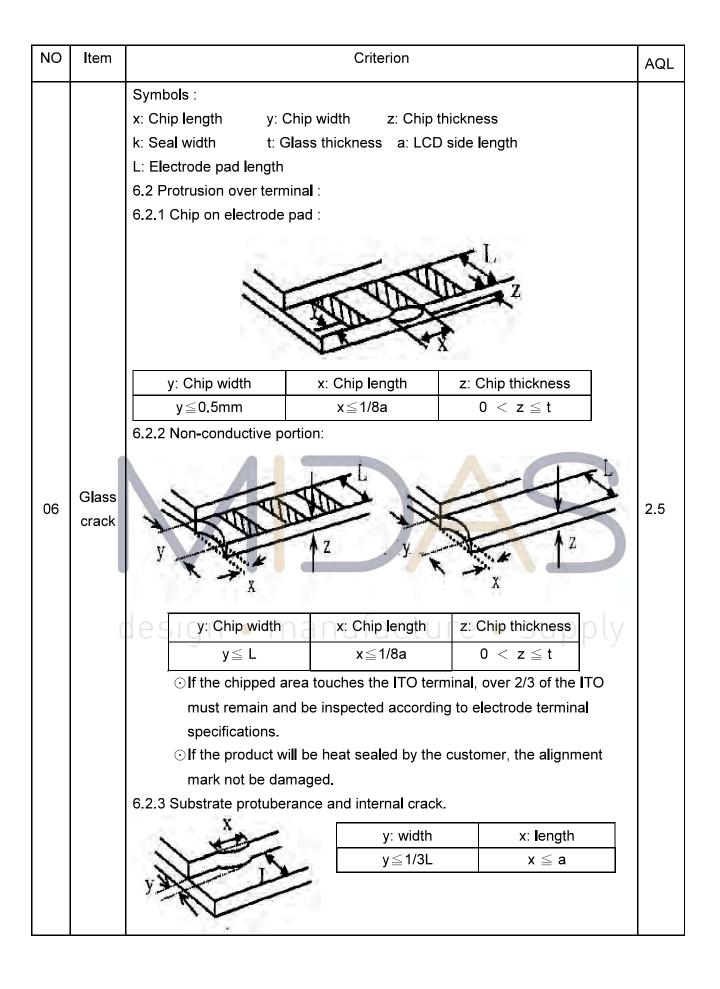
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

Inspection specification

NO	Item			Criterion		AQL	
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 					
02	Black or white spots on LCD (display only)	three white or	black sp	•	mm, no more than or lines within 3mm	2.5	
LCD black spots, white		3.1 Round type : Φ=(x+y)/2	Y	fing drawing $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0	2.5	
	spots, contamination (non-display)	3.2 Line type : (A	s followin Length L≦3.0 L≦2.5	yidth W≦0.02 0.02 <w≦0.03 0.03<w≦0.05="" 0.05<w<="" td=""><td>Acceptable Q TY Accept no dense 2 As round type</td><td>2.5</td></w≦0.03>	Acceptable Q TY Accept no dense 2 As round type	2.5	
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must check specify direction.	spot t easy ck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5	

NO	Item	Criterion					
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination					
05	Chipped glass	Symbols Define: x: Chip length y: 0 k: Seal width t: 0 L: Electrode pad length 6.1 General glass chip 6.1.1 Chip on panel sur z: Chip thickness Z≤1/2t 1/2t < z≤2t	Chip width z: Chip to Slass thickness a: LCE	thickness D side length panels: x: Chip length x≤1/8a x≤1/8a	2.5		
		1/2t < z ≦ 2t	Not exceed 1/3k	x≦1/8a			
		⊙If there are 2 or more	chips, x is the total leng	gth of each chip.			



NO	Item	Criterion			
07	Cracked glass	The LCD with extensive crack is not acceptable.			
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 			
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65		
10	PCB·COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 0.65 2.5 2.5		
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65		

NO	Item	Criterion			
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5		
	Genera l appearance	12.2 No cracks on interface pin (OLB) of TCP.	0.65		
		12.3 No contamination, solder residue or solder balls on product.	2.5		
		12.4 The IC on the TCP may not be damaged, circuits.	2.5		
		12.5 The uppermost edge of the protective strip on the interface			
12		pin must be present or look as if it cause the interface pin to			
		sever. 12.6 The residual rosin or tin oil of soldering (component or chip			
		component) is not burned into brown or black color.	2.5		
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65		
		12.8 Pin type must match type in specification sheet.	0.65		
		12.9 LCD pin loose or missing pins.	0.65		
		 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product 			
		specification sheet.			
		12.12 Visua <mark>l d</mark> efect outside of VA is not considered to be rejection.			

Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

Material List of Components for RoHs

1. Midas Displays hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Va l ue	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.										

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface: the surface of Pb-free solder is rougher than we used before.

design • manufacture • supply

(2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp.: 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.